



NPN SURFACE MOUNT TRANSISTOR

Features

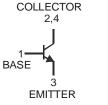
- **Epitaxial Planar Die Construction**
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Complementary PNP Type Available (2DA1797)
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

- Case: SOT89-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.055 grams (approximate)









Device Schematic

Top View Pin Out Configuration

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	60	V
Collector-Emitter Voltage	V _{CEO}	50	V
Emitter-Base Voltage	V_{EBO}	6	V
Peak Pulse Current	I _{CM}	6	Α
Continuous Collector Current	lc	3	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ T _A = 25°C	P _D	0.9	W
Thermal Resistance, Junction to Ambient Air (Note 3) @ T _A = 25°C	$R_{ heta JA}$	139	°C/W
Power Dissipation (Note 4) @ T _A = 25°C	P _D	2	W
Thermal Resistance, Junction to Ambient Air (Note 4) @ T _A = 25°C	$R_{ heta JA}$	62.5	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Conditions
OFF CHARACTERISTICS				•	•	•
Collector-Base Breakdown Voltage	V _{(BR)CBO}	60	_		V	$I_C = 50 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 5)	V _{(BR)CEO}	50	_	_	V	$I_{C} = 1 \text{mA}, I_{B} = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	6	_	_	V	$I_E = 50 \mu A, I_C = 0$
Collector Cut-Off Current	I _{CBO}	_	_	0.1	μΑ	$V_{CB} = 60V, I_{E} = 0$
Emitter Cut-Off Current	I _{EBO}	_	_	0.1	μА	$V_{EB} = 5V, I_{C} = 0$
ON CHARACTERISTICS (Note 5)						
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		105	350	mV	$I_C = 1A, I_B = 50mA$
DC Current Gain		82	_	270		V _{CE} = 2V, I _C = 500mA
	h _{FE}	45	_	_		$V_{CE} = 2V, I_{C} = 1.5A$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C _{obo}	_	17	_	pF	$V_{CB} = 10V$, $I_E = 0$, $f = 1MHz$
Current Gain-Bandwidth Product	f _T	_	180	_	MHz	V _{CE} = 2V, I _C = 100mA, f = 100MHz

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Notes:

- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Device mounted on FR-4 PCB with minimum recommended pad layout.
- Device mounted on FR-4 PCB with 1 inch² copper pad layout.
- Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤2%.



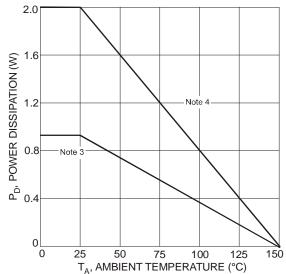
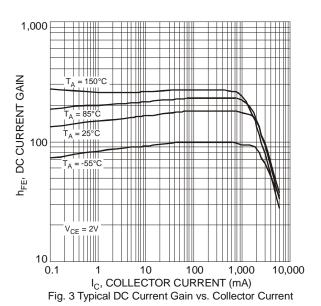
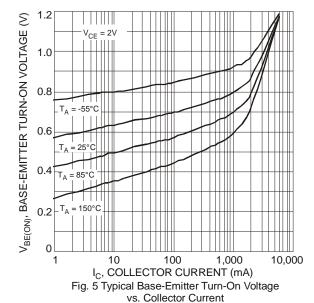


Fig. 1 Power Dissipation vs. Ambient Temperature





1.0 $I_B = 5mA$ 8.0 I_C, COLLECTOR CURRENT (A) $I_B = 4mA$ 0.6 $I_B = 3mA$ 0.4 $I_B = 2mA$ 0.2 $I_B = 1mA$ 0 2 4 6 10 V_{CE} , COLLECTOR-EMITTER VOLTAGE (V) Fig. 2 Typical Collector Current

vs. Collector-Emitter Voltage

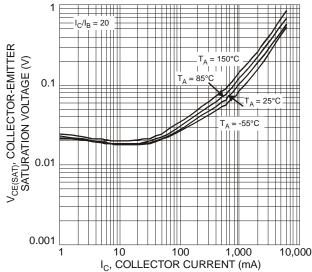


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

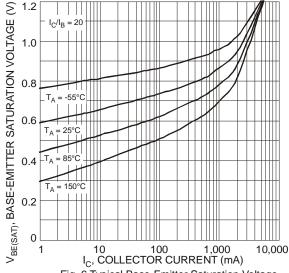
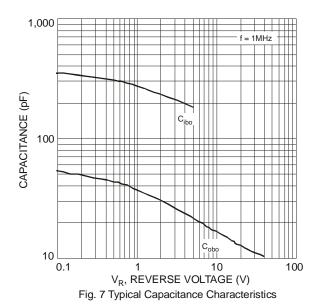
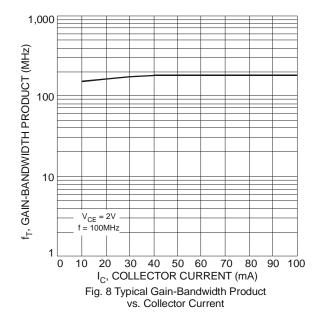


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current





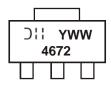


Ordering Information (Note 6)

ı	Part Number	Case	Packaging
	2DC4672-13	SOT89-3L	2500/Tape & Reel

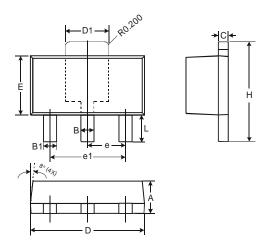
Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



4672 = Product Type Marking Code YWW = Date Code Marking Y = Last digit of year (ex: 8 = 2008) WW = Week code 01 - 53

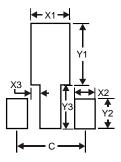
Package Outline Dimensions



	SOT89-3L			
Dim	Min	Max		
Α	1.40	1.60		
В	0.44	0.62		
B1	0.35	0.54		
С	0.35	0.43		
D	4.40	4.60		
D1	1.52	1.83		
Е	2.29	2.60		
е	1.50 Typ			
e1	3.00 Typ			
Н	3.94	4.25		
L	0.89	1.20		
All Dimensions in mm				



Suggested Pad Layout



Dimensions	Value (in mm)
X1	1.7
X2	0.9
Х3	0.4
Y1	2.7
Y2	1.3
Y3	1.9
С	3.0

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